

10000020-120401

INVENTOR INFORMATION

Inventor One Given Name:: MASAMOTO
Family Name:: TAGO
Postal Address Line One:: C/O NEC CORPORATION, 7-1,
Postal Address Line Two:: SHIBA 5-CHOME, MINATO-KU
City:: TOKYO
Country:: JAPAN
City of Residence:: TOKYO
Country of Residence:: JAPAN
Citizenship Country:: JAPAN

Inventor Two Given Name:: YOSHIHIRO
Family Name:: TOMITA
Postal Address Line One:: C/O MITSUBISHI DENKI KABUSHIKI
Postal Address Line Two:: KAISHA, 2-3, MARUNOUCHI
Postal Address Line Three:: 2-CHOME, CHIYODA-KU
City:: TOKYO
Country:: JAPAN
City of Residence:: TOKYO
Country of Residence:: JAPAN
Citizenship Country:: JAPAN

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 000466
Name Line One:: YOUNG & THOMPSON
Address Line One:: 745 SOUTH 23RD STREET
Address Line Two:: SECOND FLOOR
City:: ARLINGTON
State or Province:: VIRGINIA
Country:: U.S.A.
Postal or Zip Code:: 22202
Telephone:: 703-521-2297
Fax One:: 703-685-0573
Fax Two:: 703-979-4709

APPLICATION INFORMATION

Title Line One:: METHOD FOR LAMINATING AND MOUNTING
Title Line Two:: SEMICONDUCTOR CHIP
Total Drawing Sheets:: FOUR
Formal Drawings?: YES
Application Type:: UTILITY
Docket Number:: WNZ-2427

REPRESENTATIVE INFORMATION

Representative Customer Number:: 000466

PRIOR FOREIGN APPLICATION

Foreign Application One:: 2000-368539
Filing Date:: 04 DECEMBER 2000
Country:: JAPAN
Priority Claimed:: YES